

# SPECIFICATIONS FOR LCD MODULE

CUSTOMER	
CUSTOMER PART NO.	
AMPIRE PART NO.	AM-1280800WZTZQW-T51H
APPROVED BY	
DATE	

□ Preliminary Specification

□ Approved Specification

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This specification is subject to change without notice

# RECORD OF REVISION

Revision Date	Page	Contents	Editor
2022/03/21		New Release	Mark

#### **1.0 General Descriptions**

#### 1.1 Introduction

The LCM is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. It is composed of a TFT LCD panel, a backlight system, column driver and row driver circuit. This TFT LCD has a 10.1-inch diagonally measured active display area with WXGA resolution (1280 horizontal by 800 vertical pixels array).

#### 1.2 Features

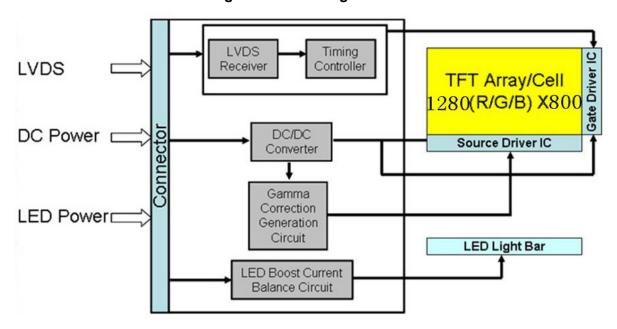
- 10.1" TFT LCD Panel
- LED Backlight System
- Supported WXGA 1280x800 pixels resolution
- Compatible with RoHS Standard
- Touch Panel:
- Controller: ILI2511
- Interface: I2C
- Cover Glass: T=1.1mm

1.5 Floudet Summary		
Items	Specifications	Unit
Screen Diagonal	10.1	Inch
Active Area	216.96(H) x 135.6(V)	mm
Pixel Format	1280(RGB) x800	-
Pixel Pitch	0.1695(H)×0.1695 (V)	mm
Pixel Arrangement	R.G.B. Vertical Stripe	-
Display Mode	Normally Black	-
White Luminance	295(Typ)	cd /m2
Contrast Ratio	800 : 1 (Typ)	-
Response Time	25	msec
Input Voltage	3.3	V
Weight	160 (Max)	g
Electrical Interface (Logic)	LVDS	-
Support Color	16.7M	-
Surface Treatment	Glare, Hard-Coating (3H)	-

#### 1.3 Product Summary

#### 1.4 Functional Block Diagram

Shows the functional block diagram of the LCD module.



#### Figure 1 Block Diagram

#### 2.0 Absolute Maximum Ratings

			0		
Item	Symbol	Min	Max	Unit	Conditons
Logic Supply Voltage	Vdd	-0.3	4.0	V	TA=25℃
Supply VLED Voltage	VLED	-0.3	24	V	TA=25℃

#### **Table 1 Electrical Absolute Ratings**

Table 2 Reliability Absolute Ratings

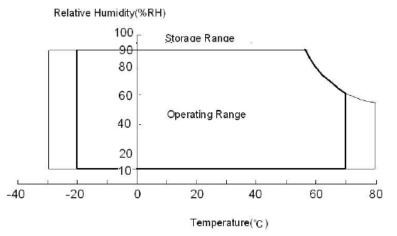
Item	Symbol	Min	Max	Unit	Conditons
Operating Temperature	TOP	-20	70	°C	Note
Operating Humidity	HOP		90	%RH	Note
Storage Temperature	TST	-30	80	°C	Note
Storage Humidity	HST		90	%RH	Note

Note: (1) Maximum Wet-Bulb temperature should be 39 degree C and no condensation.

(2) When you apply the LCD module for OA system. Please make sure to keep the temperature of

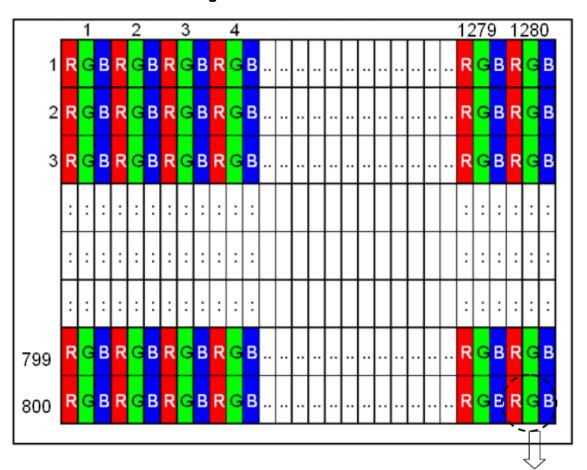
LCD module is less than  $70^{\circ}\mathrm{C}$ 

(3) Storage /Operating temperature



#### 3.0 Pixel Format Image

Figure 2 shows the relationship of the input signals and LCD pixel format image.



# Figure 2 Pixel Format

R+G+B dots=1 pixel

#### 4.0 Optical Characteristics

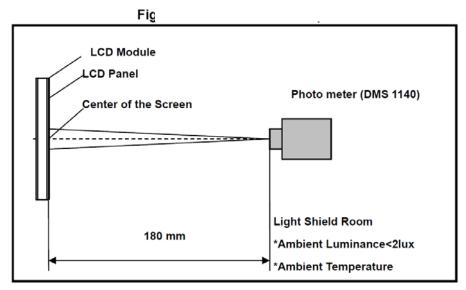
The optical characteristics are measured under stable conditions as following notes

ltem	Conditions	T	Min.	Тур.	Max.	Unit	Note	
	Horizontal	θL	(75)	(85)	-			
Viewing Angle (CR>10)		θR	(75)	(85)	-	degree	(1),(2),(3)	
(CR>10)	Vertical	θτ	(75)	(85)	-		('),(-),(-)	
	Ventical	θв	(75)	(85)	-			
Contrast Ratio	Center		(600)	(800)	-	-	(1),(2),(4)	
Response Time	Rising		-	-	-	ms		
	Falling		-	-	-	ms	(1),(2),(5)	
	Rising + Falling		-	25	-	ms		
	NTSC		-	45	-	%	(1),(2)	
	Red	Х		0.561		-		
	Red	у		0.334		-		
Color	Green	Х	Тур.	0.341	Тур.	-		
Chromaticity	Green	у	-0.03	0.568	+0.03	-	(1),(2)	
(CIE1931)	Blue	Х		0.161		-	(1),(2)	
	Blue	у		0.129		-		
	White	Х	-	0.313	-	-		
	White	у	-	0.329	-	-		
White Luminance	Center		255	295	-	cd/m^2	(1),(2),(6)	
Luminance Uniformity	9Points		70	75	-	%	(1),(2),(6)	

#### **Table 2 Optical Characteristics**

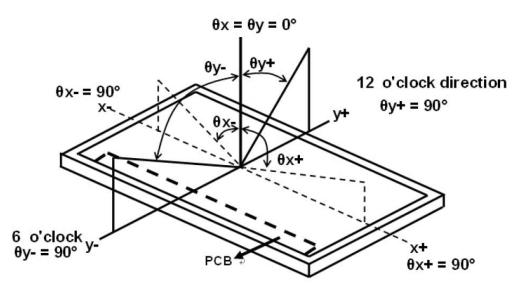
#### Note(1) Measurement Setup:

The LCD module should be stabilized at given temperature(25°C) for 15 minutes to Avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 15 minutes in a windless room.



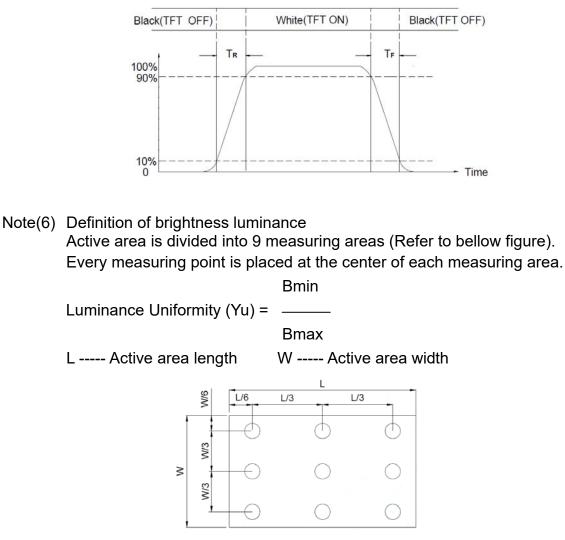
Note(2) The LED input parameter setting as:PWM: duty 100 %

Note(3) Definition of viewing angle:



Note(4) Definition of Contrast Ratio (CR) The contrast ratio can be calculated by the following expression Contrast Ratio (CR) = L255 / L0 L63: Luminance of gray level 255, L0: Luminance of gray level 0





Bmax: The measured maximum luminance of all measurement position. Bmin: The measured minimum luminance of all measurement position.

#### 5.0 Backlight Characteristics

#### 5.1 Parameter Guideline Of LED Backlight

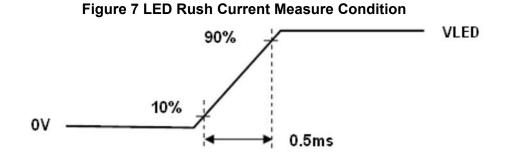
Table 3 Parameter Guideline for LED Backlight									
Symbol	Parameter		Min.	Тур.	Max.	Units	Condition		
VLED	LED Inpu	t	(6)	(12)	(21)	[V]	Ta=25℃ Note B		
PLED	LED Powe Consumption		-	-	(2.5)	W	Ta=25℃ Note B		
	PWM Signal	High	3.0		3.6	V	To-25°C		
VLED_PWM	Voltage	Low	0		0.4	V	Ta=25℃		
			100	-	200		D <sub>DIM</sub> ≥0.1%		
				-	500		D <sub>DIM</sub> ≥0.25%		
			500	-	1000		D <sub>DIM</sub> ≥0.5%		
Fрwм	PWM dimm	ing	1000	-	2000	Hz	D <sub>DIM</sub> ≥1%		
FPWM	Frequency	У	2000	-	5000		D <sub>DIM</sub> ≥2.5%		
			5000	-	10000		D <sub>DIM</sub> ≥5%		
			10000	-	20000		D <sub>DIM</sub> ≥10%		
			20000	-	30000		D <sub>DIM</sub> ≥15%		
	LED Enable	High	3.0		3.6	V			
VLED_EN	Voltage	Low	0	-	0.4	V	-		
LT	LED Life Time		20,000	25,000	-	Hours	Ta=25℃ Note A		

#### Table 3 Parameter Guideline for LED Backlight

Note A: The LED life time define as the estimated time to

50% degradation of initial luminous.

Note B: A higher LED power supply voltage will result in better power efficiency. Keep the VLED between 12V and 12.6V is strongly recommended.



# VLED rising time

#### **6.0 Electrical Characteristics**

#### 6.1 TFT LCD Module Interface Connector

#### Table 4 Connector Name / Designation

Item	Description
Manufacturer / Part Number	Starconn / 300E40-0010RA-G3
Mating Model Number	TBD or compatible

#### Table 5 Signal Pin Assignment

Pin #	Singnal Name	Description	Remarks
1	NC	Not Connect	-
2	VDD	Power Supply, 3.3V (typical)	-
3	VDD	Power Supply, 3.3V (typical)	
4	VDD EDID	Power Supply for EDID I2C Flash IC	
5	SCL EDID	I2C Serial Clock for EDID I2C Flash IC	
6	SDA EDID	I2C Serial Data for EDID I2C Flash IC	
7	NC _	Not Connect	
8	LVON	-LVDS differential data input	
9	LV0P	+LVDS differential data input	
10	GND	Ground	
11	LV1N	-LVDS differential data input	
12	LV1P	+LVDS differential data input	
13	GND	Ground	
14	LV2N	-LVDS differential data input	
15	LV2P	+LVDS differential data input	
16	GND	Ground	
17	LVCLKN	-LVDS differential data input	
18	LVCLKP	+LVDS differential data input	
19	GND	Ground	
20	LV3N	-LVDS differential data input	
21	LV3P	+LVDS differential data input	
22	GND	Ground	
23	LED_GND	Ground for LED Driving	
24	LED_GND	Ground for LED Driving	
25	LED_GND	Ground for LED Driving	
26	NC	Not Connect	
27	LED_PWM	PWM Input signal for LED driver	
28	LED_EN	LED Enable Pin	
29	NC	Not Connect	
30	NC	Not Connect	
31	LED_VCC	Power Supply for LED Driver	
32	LED_VCC	Power Supply for LED Driver	
33	LED_VCC	Power Supply for LED Driver	
34	NC	Not Connect	
35	BIST	BIST pin. (Keep NC or HIGH if not use.)	NC
36	CSB	Serial communication enables. (For test only)	NC
37	SCL	Serial communication clock input (For test only)	NC
38	SDA	Serial communication data input. (For test only)	NC
39	SCL_I2C	Serial communication clock input. (For test only)	NC
40	SDA_I2C	Serial communication data input. (For test only)	NC

Note: All input signals shall be low or Hi-resistance state when VDD is off.

#### 6.2 LVDS Receiver

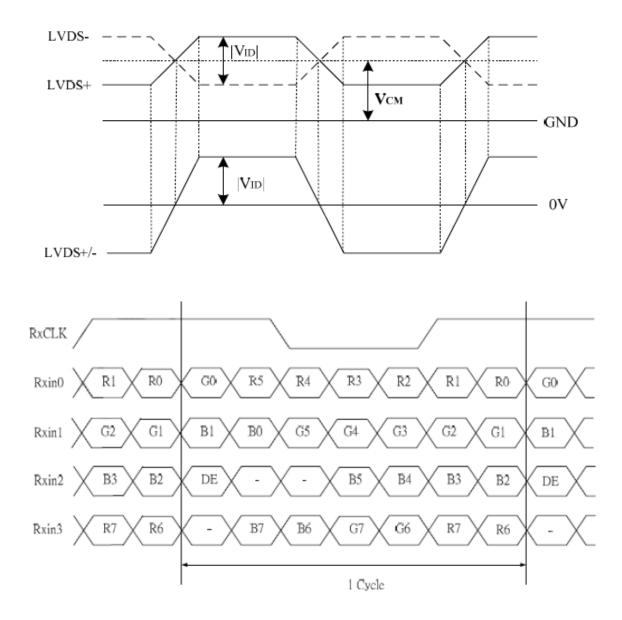
6.2.1 Signal Electrical Characteristics For LVDS Receiver

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions		
Differential Input High	Vth	-	-	+100	mV	V <sub>CM</sub> =+1.2V		
Differential Input Low	∨tI	-100	-	-	m٧	V <sub>CM</sub> =+1.2V		
Magnitude Differential Input	Vid	200	-	400	mV	-		
Common Mode Voltage	V <sub>CM</sub>	0.3+(VID/2)	-	VDD-1.2-(VID/2)	V	-		
Common Mode Voltage	$\Delta V_{CM}$	-	-	50	m٧	V <sub>CM</sub> =+1.2V		

Table 7 LVDS Receiver Electrical Characteristics

Note (1) Input signals shall be low or Hi-Z state when VDD is off.

(2) All electrical characteristics for LVDS signal are defined and shall be measured at the interface connector of LCD.



#### 7.0 Interface Timings

#### 7.1 Timing Characteristics

#### Interface Timings

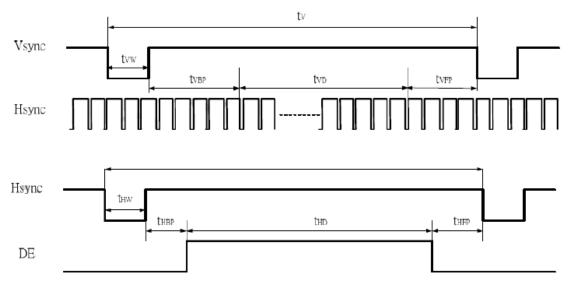
Parameter	Symbol	Min.	Тур.	Max.	Unit
LVDS Clock Frequency	Fclk	(70.0)	(72.4)	(76.6)	MHz
H Total Time	HT	(1,410)	(1,440)	(1,470)	Clocks
H Active Time	HA		1,280		Clocks
∨ Total Time	VT	(828)	(838)	(868)	Lines
V Active Time	VA		800		Lines
Frame Rate	F۷	-	(60)	-	Hz

Note1: HT \* VT \*Frame Frequency≤(76.6) MHz

Note2: All reliabilities are specified for timing specification based on refresh rate of 60Hz.

#### 7.2 Timing Diagram of Interface Signal (DE mode)





#### 8.0 Power Consumption

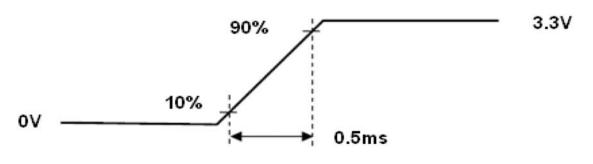
Input power specifications are as follows.

#### **Table 8 Power Consumption**

lten	I	Symbol	Min	Тур	Max	Unit	Note
LCD Drive Voltage		Vdd	3.0	3.3	3.6	V	(3)
VDD Current	/DD Current White Pattern			0.295		А	(2),(3)
VDD Power Consumption					1.2	W	(2),(3)
LED Power Consumption		PLED			2.5	W	(2),(3)
Rush Current		Irush			1.5	A	(1),(3),(4)
Allowable Logic/LC Voltage	VDDrp			300	mV	(3)	

Note (1) Measure Condition

#### Figure 9 VDD rising time

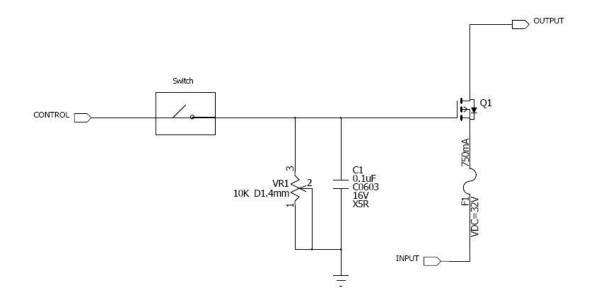


#### VDD rising time

Note (2) Frame Rate=60Hz, VDD=3.3V, DC Current.

Note (3) Operating temperature  $25^{\circ}$ C , humidity 55%RH.

Note (4) The reference measurement circuit of rush current.



#### 8.1 Power ON/OFF Sequence

Power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.

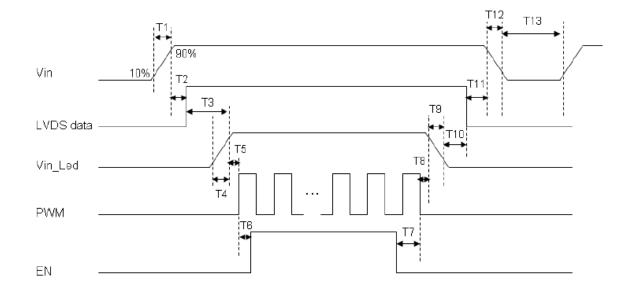


Figure 11 Power Sequence

Parameter	Symbol	Unit	Min	Тур.	Мах
VIN Rise Time	T1	ms	0.5		10
VIN Good to Signal Valid	T2	ms	30		90
Signal Valid to Backlight On	Т3	ms	200		
Backlight Power On Time	T4	ms	0.5		
Backlight VDD Good to System PWM On	T5	ms	10		
System PWM ON to Backlight Enable ON	T6	ms	10		
Backlight Enable Off to System PWM Off	T7	ms	0		
System PWM Off to B/L Power Disable	T8	ms	10		
Backlight Power Off Time	Т9	ms		10	30
Backlight Off to Signal Disable	T10	ms	200		
Signal Disable to Power Down	T11	ms	0		50
VIN Fall Time	T12	ms		10	30
Power Off	T13	ms	500		

# 9.0 Projected capacitive-type Touch panel specification 9.1 Basic Characteristic

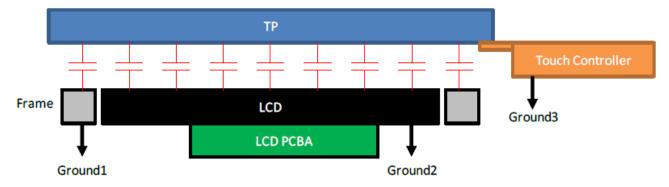
ITEM	SPECIFICATION
Туре	Projective Capacitive Touch Panel
Activation	Max 10-fingers or Signal-finger
X/Y Position Reporting	Absolute Position
Touch Force	No contact pressure required
Calibration	No need for calibration
Report Rate	Approx 80 points/sec
Interface	I2C
Control IC	ILI2511

ltem	Symbol	Min.	Тур.	Max.	Unit
Power Supply Voltage	VIN	3.14	3.3	3.46	V
Low Level Input Voltage	VIL	0		0.3*VIN	V
High Level Input Voltage	VIH	0.6*VIN		VIN	V

# 9.2 Interface

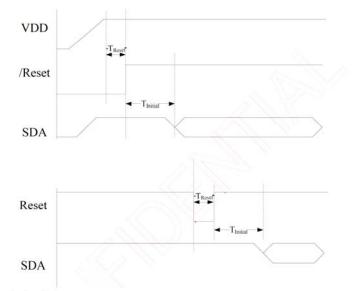
Pin No.	Symbol	Function
1	VIN	Power Supply for TP controller
2	SCL	I2C Data
3	SDA	I2C Clock
4	INT	Interrupt Request pin
5	RES	Rest pin to Master Chip
6	GND	GND

TP needs to work in environment with stable stray capacitance. In order to minimize the variation in stray capacitance, all conductive mechanical parts must not be floating. Intermittent floating any conductive part around the touch sensor may cause significant stray capacitance change and abnormal touch function. It is recommended to keep all conductive parts having same electrical potential as the GND of the touch controller module.



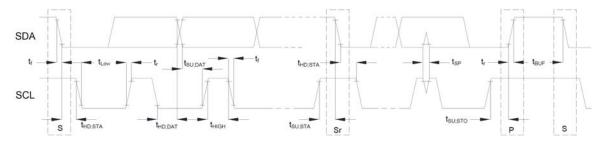
GND1, GND2 and GND3 should be connected together to have the same ground

#### 7.3 Power- on Timing Chart (IIC interface)



Symbol	Parameter	MIN.	MAX.	Unit
T <sub>Initial</sub>	After powering-on or resetting the device, the device needs I <sub>nitial</sub> time to configure the system.	-	100	ms
T <sub>Reset</sub>	/Reset pin low hold time	50	-	μs

## 9.4 IIC AC Waveform



# 9.5 IIC Characteristics

Symbol	Davamatar		100KHz	:	400KHz			
Symbol	Parameter	Min	Max	Unit	Min	Max	Unit	
f <sub>SCL</sub>	SCL clock frequency	0	100	kHz	0	400	KHz	
t <sub>hd;sta</sub>	Hold time (repeated) START condition. After this period, the first clock pulse is generated		-	μs	0.6	-	μs	
t <sub>LOW</sub>	LOW period of the SCL clock		-	μs	1.3	-	μs	
t <sub>HIGH</sub>	HIGH period of the SCL clock	4.0		μs	0.6	-	μs	
t <sub>su;sta</sub>	Set-up time for a repeated START condition	4.7		μs	0.6	-	μs	
t <sub>HD:DAT</sub>	Data hold time	0	3.45	μs	0	0.9	μs	
t <sub>su;dat</sub>	Data set-up time	250	-	ns	100	-	ns	
tr	Rise time of both SDA and SCL signals	-	1000	ns	-	300	ns	
t <sub>f</sub>	Fall time of both SDA and SCL signals	-	300	ns	-	300	ns	
t <sub>su;sto</sub>	Set-up time for STOP condition	4.0	-	μs	0.6	-	μs	
t <sub>BUF</sub>	Bus free time between a STOP and START condition	4.7	-	μs	1.3	-	μs	

# 9.6 Format Protocol Protocol V3.X Command List

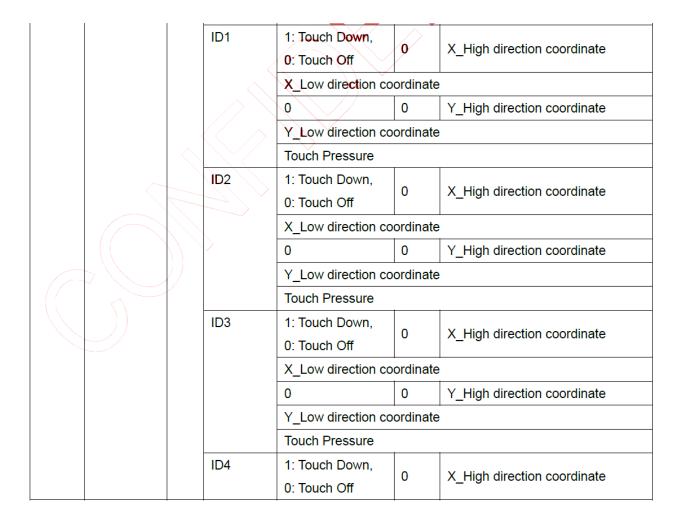
Code	Name	Set /Get	Note	b7	b6	b5	b4	b3	b2	b1	b0	
0x10	Touch	Get		0: No touch								
	Information			1: Last Report at ID	0 to ID	5 (incl						
				2: Last Report at ID 6 to ID 9 (include release status)								
			ID0	ID0 1: Touch Down,								
				0: Touch Off	0	Х_НІ	gn aire	ection	coordin	late		
				X_Low direction co	ordinate		<	N		$\bigvee$		
				0	0	Y_Hi	<b>g</b> h dire	ection o	coordin	ate		
				Y_Low direction co	ordinate	$\square$		$ \setminus                                   $				
				Touch Pressure		$\overline{\langle}$		Ú	>			
			ID1	1: Touch Down, 0: Touch Off	0	X_Hi	gh dire	ection of	coordin	ate		
				X_Low direction co	ordinate	27						
				0	0	Y_High direction coordinate						
				Y_Low direction coordinate								
				Touch Pressure	//							
			/		1	I						
			ID2	1: Touch Down, 0: Touch Off	0	X_Hi	gh dire	ction c	oordina	ate		
				X_Low direction co	ordinate							
		$\sim$		0	0	Y_Hi	gh dire	ction c	oordina	ate		
				Y_Low direction co	ordinate							
			$\langle \rangle$	Touch Pressure								
			1D3	1: Touch Down,     0     X_High direction coordina       0: Touch Off     0     X_High direction coordina					ate			
				X_Low direction co	ordinate							
				0	0	Y_Hi	gh dire	ction c	oordina	ate		
	$\square$			Y_Low direction co	ordinate							
				Touch Pressure								
			ID4	1: Touch Down, 0: Touch Off	0	X_High direction coordinate			ate			
				X_Low direction co	ordinate							
				0	0	Y Hi	gh dire	ction c	oordina	ate		
				Y_Low direction co	ordinate	_ `	-					
				Touch Pressure								

			ID5	1: Touch Down,	0	V Llink dimetian accordinate				
				0: Touch Off	0	X_High direction coordinate				
				X_Low direction co	ordinate	}				
				0	0	Y_High direction coordinate				
				Y_Low direction co	ordinate	•				
				Touch Pressure						
0x14	Touch	Get	ID6	1: Touch Down,	0	X_High direction coordinate				
	Information 2			0: Touch Off	Ŭ					
				X_Low direction co	ordinate					
				0	0	Y_High direction coordinate				
				Y_Low direction co	ordinate	,				
				Touch Pressure						
			ID7	1: Touch Down, 0: Touch Off	0	X_High direction coordinate				
				X_Low direction co	X_Low direction coordinate					
				0	0	Y_High direction coordinate				
				Y_Low direction coordinate						
				Touch Pressure	$\square$					
· ·	1	1								
			ID8	1: Touch Down, 0: Touch Off	0	X_High direction coordinate				
			$> \setminus$	X_Low direction co	ordinate	}				
			$\land$	0	0	Y_High direction coordinate				
	<	$\langle \rangle$		Y_Low direction co	ordinate	•				
				Touch Pressure						
			ID9	1: Touch Down,	0	X High direction coordinate				
				0: Touch Off	0	X_High direction coordinate				
				X_Low direction co	ordinate					
				0	0	Y_High direction coordinate				
				Y_Low direction co	ordinate	•				
	))			Touch Pressure						
0x20				The maximum X co	oordinate	e (bit 7:0)				
				The maximum X co	oordinate	e (bit 15:8)				
				The maximum Y co	oordinate	e (bit 7:0)				
				The maximum Y co	oordinate	e (bit 15:8)				
				The channel numb	ers of X	direction				
				The channel numb	ers of Y	direction				
				The maximum repo	ort points	5				

			The channel numbers of TouchKey / Scrolling Bar
			For Touch Key Application
			(Maximum supports 31 Touch Key)
			Byte 8 : The Touch Key number (<32)
			Byte 9: 0xFF
0x30	Enter Sleep Mode	Set	
0x40	Firmware Version	Get	Chip ID Code
			Major firmware version
			Minor firmware version
			Release firmware version
			For Customer Firmware Version
			For Customer Firmware Version
			For Customer Firmware Version
			For Customer Firmware Version
0x42		Get	Major protocol version . 0x03
			Minor protocol version : XX
		/	Release protocol version : XX

#### **Protocol V3.X Data Format**

CMD Code	Name	Set / Get	Note	b7	b6	b5	b4	b3	b2	b1	b0
0x10	Touch Information	Get	Packet Number	0: No touch 1: Last Report at ID	) 0 to ID	5 (incl	ude re	lease	status)		$\geq$
				<ol> <li>1: Last Report at ID 0 to ID 5 (include release status)</li> <li>2: Last Report at ID 6 to ID 9 (include release status)</li> </ol>							
			ID0	1: Touch Down, 0: Touch Off	0	X_High direction coordinate					
				X_Low direction co	ordinate		$\langle \rangle$				
				0 Y_High direction coordinate							
				Y_Low direction coordinate							
				Touch Pressure							



		X_Low direction coordinate			
		0	0	Y_High direction coordinate	
		Y_Low direction coordinate			
		Touch Pressure			
	ID5	1: Touch Down,	0	X_High direction coordinate	
		0: Touch Off			
		X_Low direction coordinate			
		0	0	Y_High direction coordinate	
		Y_Low direction coordinate			
		Touch Pressure			

### 9.7 Interrupt Pin (INT) Control

When a finger touches on the sensor surface, the INT pin will be pull low. TP controller supports two different type control method.

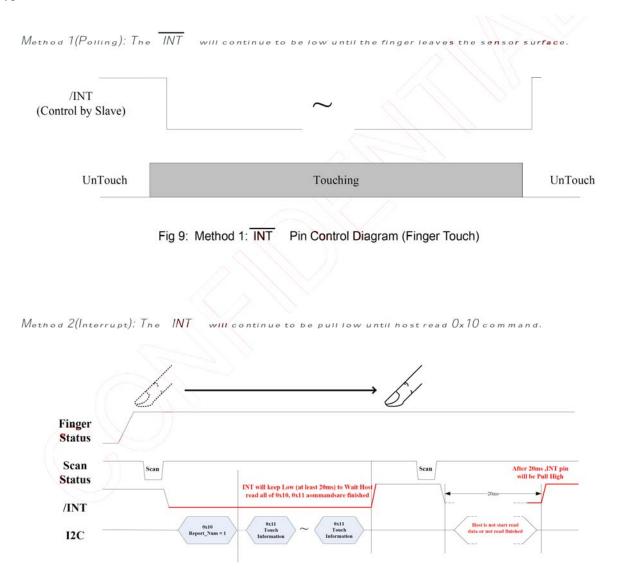
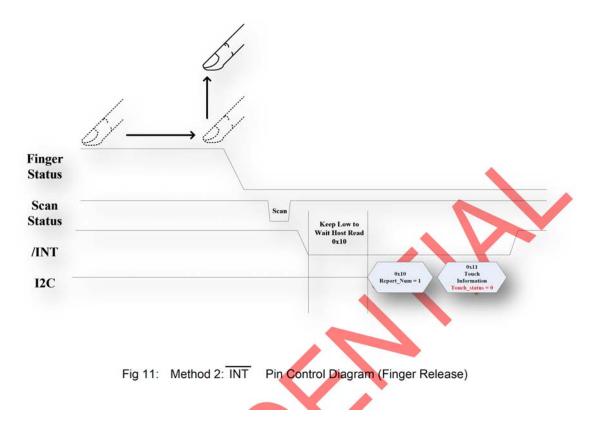


Fig 10: Method 2: INT Pin Control Diagram (Finger Touch)



#### 9.8 Device Address

MS	В						LSB
1	0	0	0	0	0	1	0/1
	R/W						

7-bit Device Address: 0x41

8-bit Device Read Address:0x83

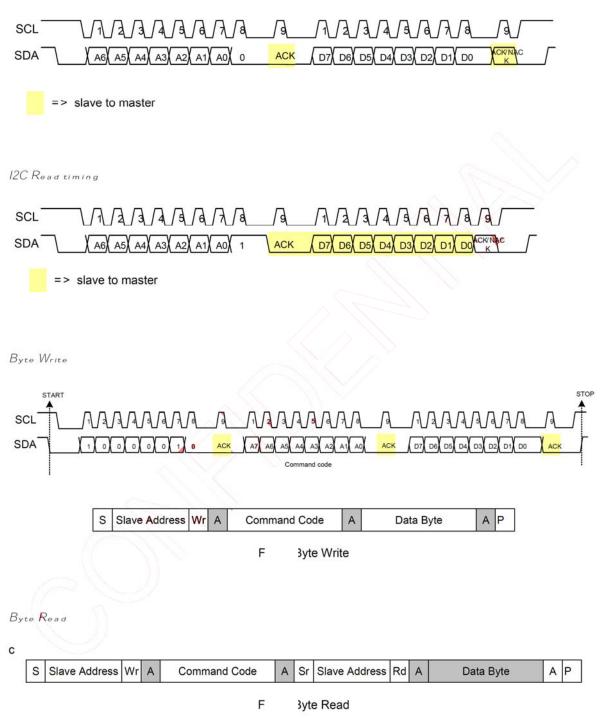
8-bit Device Write Address:0x82

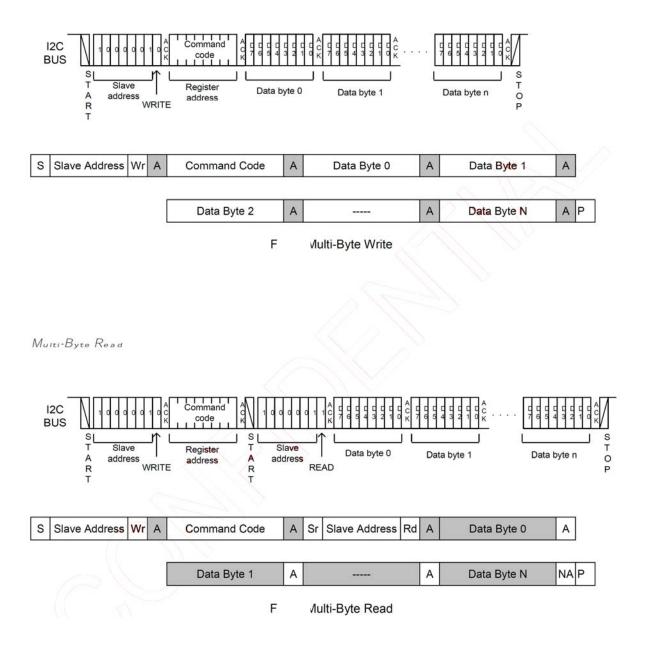
#### 9.9 Data Transfer

Data is transferred over the IIC bus with 8-bit address and 8-bit data.

	-					0				
1	1		1	1		8	J.	1	1	
S	Slave Address		Wr	Α	Da	ata Byte		Α	Р	
-						2				
	S	Start C	ondi	ion						
	Sr	Repeated Start Condition								
	Rd	Read (bit value of 1)								
	Wr	Write (bit value of 0)								
	A/NA	Acknowledge (this bit position may be '0' for an ACK or '1' for a NACK)								
	Р	Stop Condition								
	5	Master-to-Slave								
		Slave-to-Master								
	<u> </u>	Contin	ue							

12C Write timing





# **10 USE PRECAUTIONS**

#### 10.1 Handling precautions

- 1) The polarizing plate may break easily so be careful when handling it. Do not touch, press or rub it with a hard-material tool like tweezers.
- 2) Do not touch the polarizing plate surface with bare hands so as not to make it dirty. If the surface or other related part of the polarizing plate is dirty, soak a soft cotton cloth or chamois leather in benzine and wipe off with it. Do not use chemical liquids such as acetone, toluene and isopropyl alcohol. Failure to do so may bring chemical reaction phenomena and deteriorations.
- 3) Remove any spit or water immediately. If it is left for hours, the suffered part may deform or decolorize.
- 4) If the LCD element breaks and any LC stuff leaks, do not suck or lick it. Also if LC stuff is stuck on your skin or clothing, wash thoroughly with soap and water immediately.

# 10.2 Installing precautions

- 1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx.  $1M\Omega$  and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.
- 2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
- 3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
- 4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

#### **10.3 Storage precautions**

- 1) Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
- 2) Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.
- 3) Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

#### **10.4 Operating precautions**

- 1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
- 2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
- The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
- 4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
- 5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
- 6) The CMOS ICs are incorporated in the module and the pull-up and pull-down function is not adopted for the input so avoid putting the input signal open while the power is ON.

- 7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.
- 8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

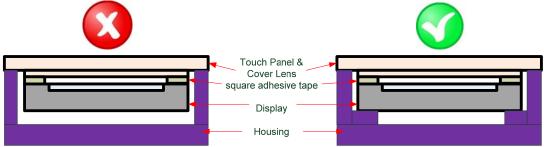
#### 10.5 Other

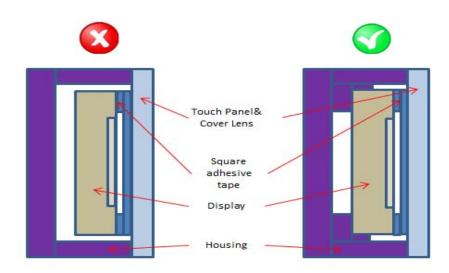
- 1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
- 2) Do not keep the LCD at the same display pattern continually. The residual image will happen and it will damage the LCD. Please use screen saver.
- 3) AMIPRE will provide one year warrantee for all products and three months warrantee for all repairing products.

#### 10.6 Mechanism

(1) Please mount LCD module by using mounting holes arranged in four corners tightly.

(2) The square adhesive tape which is between the touch panel and display can't provide well supporting in the long term and high ambient temperature condition. Whether upright or horizontal position the support holder which is in the back side of the display is needed. Do not let the display floating.





#### **11 MECHANIC DRAWING**

